

# **Deep-Level Transient Spectroscopy in InGaAsN Lattice-Matched to GaAs**

**Preprint**

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*To be presented at the 29<sup>th</sup> IEEE PV Specialists Conference  
New Orleans, Louisiana  
May 20-24, 2002*



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Contract No. DE-AC36-99-GO10337

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# DEEP-LEVEL TRANSIENT SPECTROSCOPY IN InGaAsN LATTICE-MATCHED TO GaAs

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## ABSTRACT

Deep-level transient spectroscopy (DLTS) measurements have been performed on the quaternary semiconductor InGaAsN. A series of as-grown, metal-organic chemical vapor deposited samples having varying composition were grown and measured. A GaAs sample was used as a baseline for comparison. After adding only In to GaAs, we did not detect significant additional defects; however, adding N and both N and In led to larger hole-trap peaks and additional electron-trap peaks in the DLTS data. The samples containing about 2% N, with and without about 6% In, had electron traps with activation energies of about 0.2 and 0.3 eV. A sample with 0.4% N had an electron trap with an activation energy of 0.37 eV.

## INTRODUCTION

The quaternary semiconductor InGaAsN can be grown epitaxially on GaAs, and a bandgap near 1 eV can be attained [1-5]. Both of these properties are advantageous to developing a four-junction high-efficiency solar cell, consisting of GaInP, GaAs, InGaAsN, and Ge. Such a structure has an ideal AM0 efficiency of 41% [6], but to date, InGaAsN minority-carrier properties have not been good enough to be useful in multijunction cells [5,7,8]. Deep-level transient spectroscopy (DLTS) is a powerful technique for characterizing material defects and impurities and can provide information to identify lifetime-killing defects that degrade device performance.

## EXPERIMENT

A series of metal-organic chemical vapor deposited (MOCVD) samples having varying composition were grown on conductive GaAs substrates. An ohmic contact was deposited on the back surface, and Schottky contacts 0.75 mm in diameter were deposited on the as-grown layers. Estimates of N content were obtained by x-ray diffraction [8]. The samples were then characterized by measuring room-temperature carrier concentration using the capacitance-voltage (C-V) technique [9]. Table 1 shows each sample's composition and room-temperature carrier concentration.

DLTS data were collected using up to 12 rate windows of different time constants. Temperature was scanned at a rate of 10 K per minute, and data for each rate window were collected during both upward and downward tem-

perature sweeps. These data were then averaged to account for any temperature lag between the thermocouple and the sample.

Table 1. Carrier Concentration of Samples Measured by Capacitance-Voltage

Sample	% In	% N	p-type [ $N_a$ ] ( $\text{cm}^{-3}$ )
GaAs	0	0	1.9e16
InGaAs	6	0	2.0e16
InGaAsN	6	0.4	6.2e16
InGaAsN	6	2	2.1e17
GaAsN	0	2	1.8e17

DLTS data for the 0.1-ms rate window during the heating cycle are shown in Fig. 1.

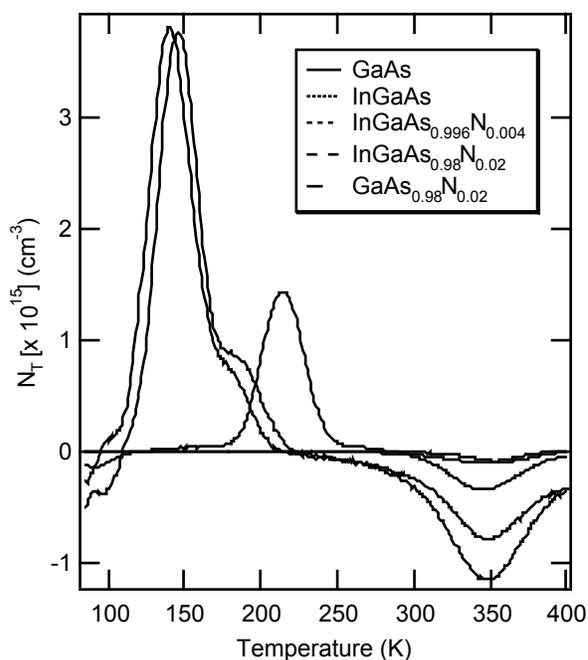


Fig. 1. Trap concentration from DLTS measurement using 0.1-ms rate window, 1-V reverse bias, 1-V pulse height, and 10-ms pulse width.

Data were collected with an applied reverse bias of 1 V, a pulse amplitude of 1 V (to 0 V), and a pulse width of 10 ms. The  $\Delta C$  values are the capacitance changes during the rate windows and are plotted as trap density by using the relation of Eq. 1 [10].

$$N_T(T) = 2N_a \frac{\Delta C(T)}{C(T)} \quad (1)$$

$N_T$  is trap concentration,  $N_a$  is p-type hole concentration determined from room-temperature C-V curves, and  $C$  is the capacitance under the reverse-bias condition of 1 V.

The maximum temperature points are then plotted on an Arrhenius plot with the corresponding rate-window time constants. These data for the five samples are shown in Fig. 2. Open symbols correspond to majority-carrier hole traps (negative peaks), whereas filled symbols correspond to electron traps (positive peaks). The data points are fit by linear equations, giving slope and intercept values.

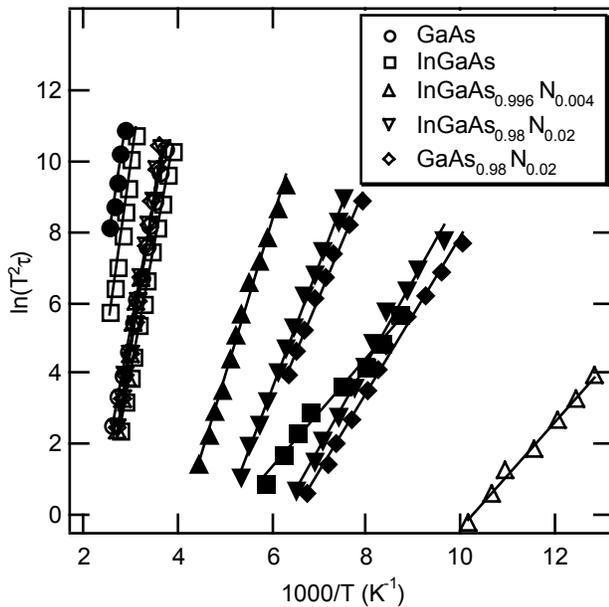


Fig. 2. Arrhenius plot of DLTS data collected on samples using 1-V reverse bias, 1-V pulse amplitude, and 10-ms pulse width. Open symbols show hole traps.

Optical DLTS data were also collected by using a pulsed xenon flashlamp, in substitution of electrical pulses, to fill trap levels. The samples were similarly reverse-biased at 1 V. These data are summarized in the Arrhenius plot shown in Fig. 3. Only positive peaks were detected; thus, all defect levels are electron traps.

The DLTS data from the Arrhenius plots are summarized in Table 2. The activation energies,  $E_a$ , and capture cross sections,  $\sigma_\infty$ , are determined from the Arrhenius plots' slope and intercept values [10].

## DISCUSSION

Electrical-pulse DLTS data show that each sample contains a hole trap with the peak occurring near 350 K, as seen in Fig. 1. These activation energies range from  $\sim 0.62$  eV for no N content to  $\sim 0.77$  eV with N added. Hole trap concentrations increase from about  $10^{14}$   $\text{cm}^{-3}$  with little to no N, to  $\sim 10^{15}$   $\text{cm}^{-3}$  with about 2% N. The capture cross section for this hole trap increases from  $\sim 10^{-14}$   $\text{cm}^2$  with no N, to  $\sim 10^{-12}$   $\text{cm}^2$  with added N. This trap may be a native defect or a complex including a native defect that has previously been reported at 0.72 eV in GaAs grown under Ga-rich conditions [11].

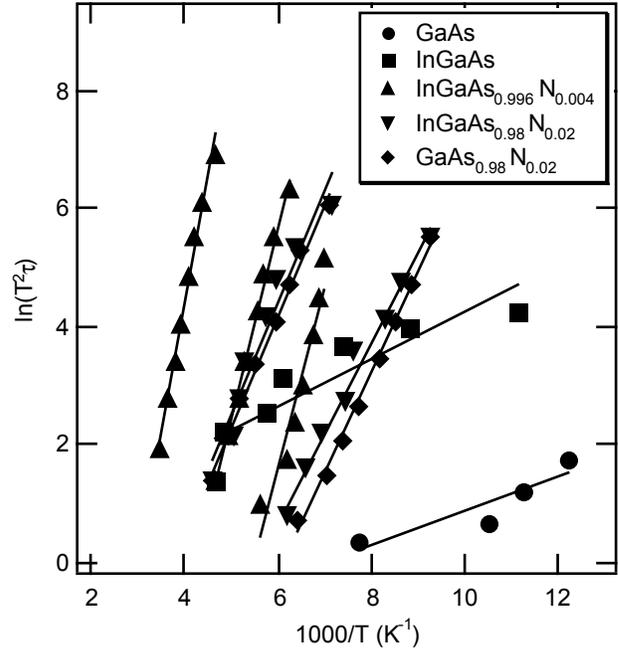


Fig. 3. Arrhenius plot of optical DLTS data collected on samples using a xenon flashlamp and applied reverse bias of 1 V.

The band-to-impurity lifetime can be estimated from Eq. 2 [12],

$$\tau = (\sigma_\infty v_{th} N_T)^{-1} \quad (2)$$

where  $v_{th}$  is thermal velocity and is defined in Eq. 3 [12].

$$v_{th} = \frac{3k_B T}{m^*}^{1/2} \quad (3)$$

Using Boltzmann's constant,  $k_B$ , a temperature of 300 K, and a GaAs hole conductivity effective mass of 0.34  $m_0$ ,  $v_{th}$  is  $2.0 \times 10^7$  cm/s. The lifetime of Eq. 2 assumes a temperature-independent capture cross section, low injection of excess carriers, and a deep trap level. The lifetime values decrease from an average value of 35 ns with no N, to an average value of 0.023 ns with N added. These lifetimes correspond to previously measured values using time-resolved photoluminescence [13]. Here, lifetimes for n-type GaAsN ranged from  $\sim 10$  ns with no N, to values between 0.1 and 1 ns with N added.

Table 2. Summary of Electrical-Pulse and Optical DLTS on the Series of InGaAsN Alloy Samples

Sample	Electrical pulse					Optical pulse (All electron traps)		
	Trapped carriers	Activation energy $E_a$ (eV)	Trap density $N_T$ ( $\text{cm}^{-3}$ )	Capture cross section $\sigma_\infty$ ( $\text{cm}^2$ )	Lifetime $\tau$ (ns)	Activation energy $E_a$ (eV)	Trap density $N_T$ ( $\text{cm}^{-3}$ )	Capture cross section $\sigma_\infty$ ( $\text{cm}^2$ )
GaAs	hole	0.62	$9.2 \times 10^{13}$	$1.1 \times 10^{-14}$	49	.024	$6.4 \times 10^{14}$	$3.3 \times 10^{-20}$
	electron	0.82	$4.1 \times 10^{12}$	$6.5 \times 10^{-14}$	140			
InGaAs	electron	0.13	$2.5 \times 10^{12}$	$1.2 \times 10^{-17}$	$1 \times 10^6$	.034	$1.1 \times 10^{13}$	$3.5 \times 10^{-21}$
	hole	0.61	$1.0 \times 10^{14}$	$2.8 \times 10^{-14}$	18			
	hole	0.83	$2.4 \times 10^{12}$	$1.8 \times 10^{-13}$	120			
In-GaAs <sub>0.996</sub> N <sub>0.004</sub>	hole	0.13	$1.4 \times 10^{14}$	$5.0 \times 10^{-15}$	71	0.26	$4.4 \times 10^{14}$	$6.3 \times 10^{-14}$
	electron	0.37	$1.5 \times 10^{15}$	$2.0 \times 10^{-13}$	0.12	0.28	$6.6 \times 10^{14}$	$5.3 \times 10^{-15}$
	hole	0.79	$3.9 \times 10^{14}$	$8.3 \times 10^{-12}$	0.015	0.39	$6.5 \times 10^{13}$	$4.2 \times 10^{-15}$
InGaAs <sub>0.98</sub> N <sub>0.02</sub>	electron	0.20	$4.0 \times 10^{15}$	$3.6 \times 10^{-15}$	2.6	0.13	$3.7 \times 10^{14}$	$2.2 \times 10^{-17}$
	electron	0.31	$9.6 \times 10^{14}$	$8.5 \times 10^{-14}$	0.46	0.17	$4.1 \times 10^{13}$	$5.9 \times 10^{-18}$
	hole	0.74	$1.2 \times 10^{15}$	$1.1 \times 10^{-12}$	0.038			
GaAs <sub>0.98</sub> N <sub>0.02</sub>	electron	0.19	$3.9 \times 10^{15}$	$2.3 \times 10^{-15}$	4.2	0.15	$1.4 \times 10^{15}$	$1.6 \times 10^{-16}$
	electron	0.27	$6.4 \times 10^{14}$	$1.5 \times 10^{-14}$	3.9	0.16	$2.9 \times 10^{14}$	$7.5 \times 10^{-18}$
	hole	0.77	$8.0 \times 10^{14}$	$4.1 \times 10^{-12}$	0.015			

Electron traps are identified as positive peaks in the DLTS spectra. Normally, when measuring DLTS using a Schottky barrier contact, minority carriers are not injected into the space-charge region (SCR). However, minority carrier traps can be observed by generating carriers optically [10]. Others have reported minority-carrier-trap detection using Schottky barriers without the use of optical generation [14-17]. In these examples, minority-carrier traps were detected by either using forward-biased pulses to inject minority carriers [14,15] or by using a high Schottky barrier [16,17].

We have detected electron traps using a pulse height of 1 V and reverse biases of 1, 2, 3, and 4 V (see Fig. 4). Thus, the case of forward bias does not apply. However, a large Schottky barrier can explain electron trapping. We have measured the built-in potential of the Schottky barrier by C-V, and this value is about 0.8 V for the N-containing samples. In the neutral bulk, the difference between the Fermi level and the valence band edge is 0.1 eV. This leads to a Schottky barrier of 0.9 V. The GaAs<sub>0.98</sub>N<sub>0.02</sub> alloy has a bandgap of 1.2 eV as measured by photoluminescence [8]. Thus, the Fermi level is pinned within 0.3 eV of the conduction band at the metal/GaAsN interface.

When reverse bias is applied, the band bending increases, and the position of the quasi-Fermi level,  $E_{Fn}$ , favors filling electron traps near the interface. When a smaller reverse bias is applied (the filling pulse), the band bending relaxes, allowing  $E_{Fn}$  to remain closer to the trap energy level for more distance into the semiconductor. This favors electron traps to fill as generation creates

electron-hole pairs in the SCR. Likewise, free-carrier holes fill hole traps at the retreated edge of the SCR region near the quasi-neutral p-type bulk. After the filling pulse, the SCR widens to the corresponding larger reverse bias value, and electrons and holes trapped in the SCR favor emission according to the positions of their respective quasi-Fermi levels.

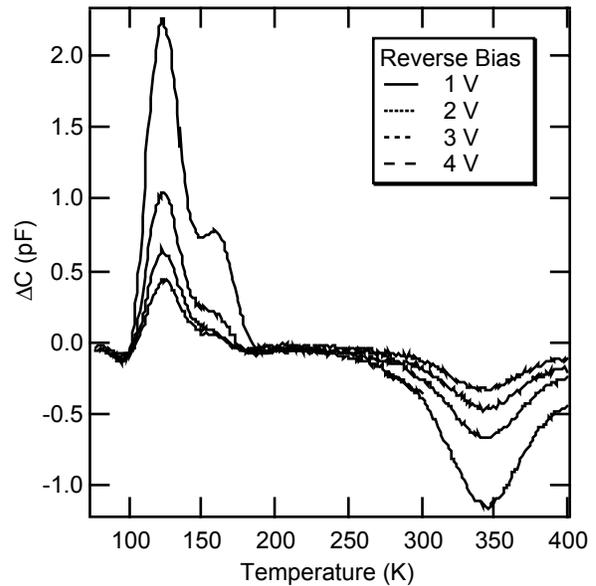


Fig. 4.  $\Delta C$  from DLTS measurement of the GaAs<sub>0.98</sub>N<sub>0.02</sub> sample using 0.1-ms rate window, varying reverse biases, and 1-V pulse height with 10 ms width.

When using electrical pulses to fill traps, a large-density ( $\sim 10^{15} \text{ cm}^{-3}$ ) electron trap appears at  $E_a = 0.37 \text{ eV}$  for  $N = 0.4\%$ . As N-content is increased to  $N = 2\%$ , electron traps appear at  $E_a = 0.20$  and  $0.31 \text{ eV}$  for the sample that included  $\sim 6\%$  In for lattice matching. Similarly, the sample with  $2\%$  N, but without In, also has electron traps with  $E_a = 0.19$  and  $0.27 \text{ eV}$ . Using Eqs. 2 and 3 with values of  $300 \text{ K}$  for temperature and  $0.19 m_0$  for electron effective mass [18], an average lifetime value for the N-containing samples is calculated to be about  $2.3 \text{ ns}$ . These electron traps are less effective recombination centers compared to the hole traps. An electron trap with "giant density at  $0.25 \text{ eV}$ " has similarly been reported for  $\text{GaAs}_{0.97}\text{N}_{0.03}$  grown by molecular beam epitaxy [19]. Here, they attribute this defect to a nitrogen-split interstitial defect on an As site. But, they also note that the measured capture cross section is too small to be an efficient recombination center [19].

In comparison to using electrical pulses to fill traps, optical DLTS data also show electron traps. For the sample with  $N = 0.4\%$ , electron trap levels with activation energies of  $0.26$ ,  $0.28$ , and  $0.39 \text{ eV}$  are observed. Similar to electrical-pulse filling, the optical DLTS data show that as N-composition increases, the electron trap levels shift to a pair of lower-activation energies. We observed electron traps with activation energies of  $0.13$  and  $0.17 \text{ eV}$  for the InGaAsN sample and  $0.15$  and  $0.16 \text{ eV}$  for the GaAsN sample.

## SUMMARY

We have seen both electron and hole traps using Schottky barriers on a series of InGaAsN samples. Hole traps were seen in each sample and were attributed to a native defect or defect complex. The band-to-impurity lifetime associated with the hole-trap parameters is about  $0.023 \text{ ns}$  for the N-containing samples. These sub-nanosecond lifetimes correspond to lifetime values of  $0.1$  to  $1 \text{ ns}$  for MOCVD GaAsN samples that were measured by photoluminescence. Electron traps were observed due to the large Schottky barrier, resulting in the position of the electron quasi-Fermi level being near the electron trap level in the vicinity of the metal-semiconductor interface. Electron traps in the sample with  $0.4\%$  N were deeper than those in the sample with  $2\%$  N. This was observed for both electrical pulsing and optical carrier generation. The electron traps having activation energies between  $0.2$  and  $0.3 \text{ eV}$  may possibly be attributed to nitrogen-split interstitial defect on As site defects. The electron traps are calculated to be less effective recombination centers than the hole traps.

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1. AGENCY USE ONLY (Leave blank)	2. REPORT DATE May 2002	3. REPORT TYPE AND DATES COVERED 29 <sup>th</sup> IEEE PVSC-Conference Paper May 20-24 2002	
4. TITLE AND SUBTITLE Deep-Level Transient Spectroscopy In InGaAsN Lattice-Matched To GaAs: Preprint		5. FUNDING NUMBERS PVP23101	
6. AUTHOR(S) S.W. Johnston, R.K. Ahrenkiel, D.J. Friedman, and Sarah R. Kurtz			
7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES) National Renewable Energy Laboratory 1617 Cole Blvd. Golden, CO 80401-3393		8. PERFORMING ORGANIZATION REPORT NUMBER	
9. SPONSORING/MONITORING AGENCY NAME(S) AND ADDRESS(ES) National Renewable Energy Laboratory 1617 Cole Blvd. Golden, CO 80401-3393		10. SPONSORING/MONITORING AGENCY REPORT NUMBER  NREL/CP-520-31401	
11. SUPPLEMENTARY NOTES			
12a. DISTRIBUTION/AVAILABILITY STATEMENT National Technical Information Service U.S. Department of Commerce 5285 Port Royal Road Springfield, VA 22161		12b. DISTRIBUTION CODE	
13. ABSTRACT ( <i>Maximum 200 words</i> ): This conference paper describes the deep-level transient spectroscopy (DLTS) measurements have been performed on the quaternary semiconductor InGaAsN. A series of as-grown, metal-organic chemical vapor deposited samples having varying composition were grown and measured. A GaAs sample was used as a baseline for comparison. After adding only In to GaAs, we did not detect significant additional defects; however, adding N and both N and In led to larger hole-trap peaks and additional electron-trap peaks in the DLTS data. The samples containing about 2% N, with and without about 6% In, had electron traps with activation energies of about 0.2 and 0.3 eV. A sample with 0.4% N had an electron trap with an activation energy of 0.37 eV.			
14. SUBJECT TERMS: PV; deep-level transient spectroscopy (DLTS); quaternary semiconductor; metal-organic chemical vapor deposited (MOCVD); four-junction; device performance; capacitance voltage; Arrhenius plot; Boltzmann's constant; quasi-Fermi level; Schottky barriers;		15. NUMBER OF PAGES	
		16. PRICE CODE	
17. SECURITY CLASSIFICATION OF REPORT Unclassified	18. SECURITY CLASSIFICATION OF THIS PAGE Unclassified	19. SECURITY CLASSIFICATION OF ABSTRACT Unclassified	20. LIMITATION OF ABSTRACT  UL